

FP-410

Auto IC Sorting & Taping Machine Wafer Level Chip Scale Package



Feature

- Able to connect to the test system (optional: customized)
- 5S Inspection minimum 10um
- With 5S Fail recycle wafer tray (2")

Specifications 規格		Specifications 規格	
Wafer Size 晶圓尺寸	8"、12"	Static Protection 靜電防護	100mm, ±1000V~±100V<5sec
Chip Size(mm) 晶粒尺寸	0.2mm * 0.2mm~8mm * 8mm	Compressed Air 壓縮空氣	5 kg/cm2
Chip Thickness 晶粒厚度	0.1mm~1.5mm	Vacuum 真空	>0.9 kg/cm
Accuracy 置晶精度	XY±25µm, θ±1°	Power 電壓	220 VAC /Single Phase, 6A(Operation), 8A(Peak), 50/60 Hz
Pick and place force 挑揀手臂克重	30g~80g	Power 功率	3000W
Tape Reel 收料載具型式	7" & 13" Reel	Weight 重量	1250kg
5S Inspection 檢測能力	Resolution 10um(Minimum)	Dimension(W * D * H) 尺寸	1800 * 2600 * 1750(mm) (without tower light)
Loading/Unloading 載入/載出	Automatic		